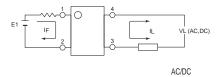
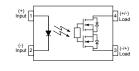
## **SUPSIC®**

Parameter	Symbol	Rating	Units	
Load Voltage	VL	400	V	
Load Current	lL .	0.3	Α	
On-Resistance	Ron	8	Ω	
I/O Isolation Voltage	V/ıo	2500	Vrms	



(Unit: mm)





- 1. LED Anode
- 2. LED Cathode
- 3.4. Drain(MOS FET)



SOP-4

### SUPSiC PhotoRelays

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

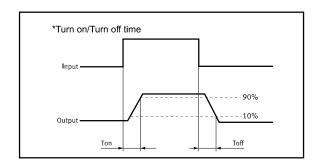
### **Applications**

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

### **TPYES**

Catagoni	Output Rating		Pooleogo	Part No.	Poolsing Overtity	
Category	Load Voltage	Load Current	Package	Part No.	Packing Quantity	
AC/DC	400V	0.3A	SOP-4	GAQY274S	2000pcs /reel	





### Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Value	Units	Note
Continuous LED Current		l <sub>F</sub>	50	mA	
Input	Peak LED Current	l <sub>FP</sub>	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pln	75	mW	
Load Voltage		VL	400	V(AC peak or DC)	
Output	Load Current	l <sub>L</sub>	0.30	Α	
	Peak Load Current	Peak	0.80	А	100ms(1 pulse)
	Output Power Dissipation	Pout	300	mW	
Total Power	Dissipation	Рт	350	mW	
I/O Isolation	n Voltage	V <sub>I/O</sub>	2500	Vrms	RH=60%, 1min
Operating T	emperature	Topr	-40 to +85	°C	
Storage Ter	mperature	T <sub>stg</sub>	-40 to +100	°C	
Pin Solderin	ng Temperature	T <sub>sol</sub>	260	°C	10 sec max.

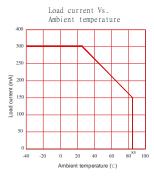
### Electrical Characteristics (Ta = 25°C)

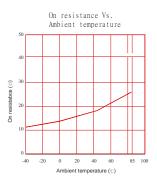
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	V <sub>F</sub>		1.2	1.4	V	I <sub>F</sub> =10mA
Input	Operation LED Current	IF on		0.5	3.0	mA	
	Recovery LED Current	I <sub>F off</sub>		0.35	0.5	mA	
	Recovery LED Voltage	V <sub>F</sub> off	0.5			V	
Output	On-Resistance	Ron		8	12	Ω	I <sub>F</sub> =5mA,I <sub>L</sub> =100mA, Time to flow is within 1 sec.
	Off-State Leakage Current	Leak	0.01	0.03	0.10	uA	V <sub>L</sub> =Rating
	Output Capacitance	Cout		60		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.5	1	ms	I <sub>F</sub> =5mA, I <sub>L</sub> =100mA,
sion	Turn-Off Time	T <sub>off</sub>		0.03	0.5	ms	
Coupled	I/O Isolation Resistance	Rı/o	10 <sup>10</sup>			Ω	DC500V
Ooupieu	I/O Capacitance	C <sub>I/O</sub>		0.8	1.5	pF	f=1MHz

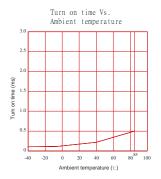
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

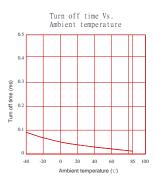


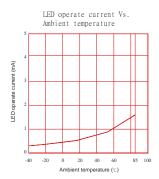
### **Engineering Data**

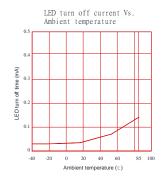


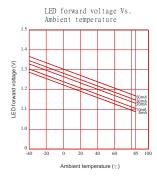


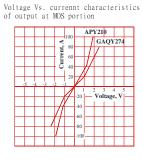


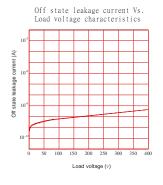


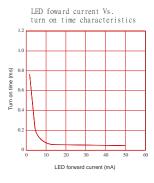


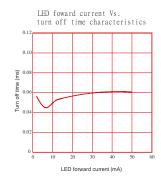


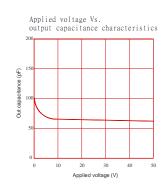










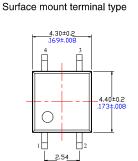


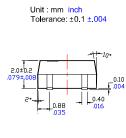


### **Dimensions and Package**

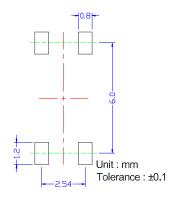
# Marking GAQY 274 YY=YEAR WW=WEEK H H A Marking PART NO.

# 0.66±0.2 .026±.008 .036

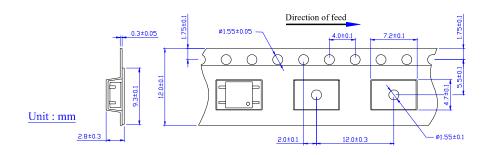


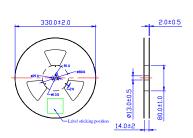


### Recommended mounting pad (Top view)

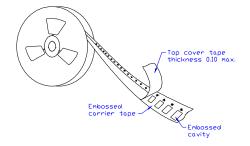


### Tape dimensions





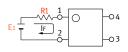
Dimensions of tape reel

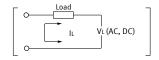




### **Using Methods**

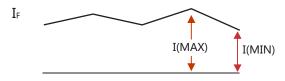
Examples of resistance value to control LED forward current (IF=5mA)





R1 (Approx)
300 Ω
600 Ω
1.9ΚΩ
4.1K Ω

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



### **Recommended Operating Conditions**

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

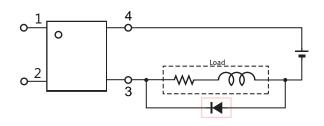
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

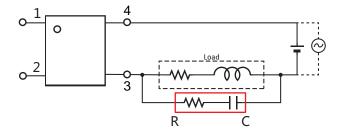
### **Protection Circuit**

Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



### **Recommended Soldering Conditions**

### (a) Infrared reflow soldering:

Peak reflow soldering: 260°C or below (package surface temperature)

Time of peak reflow temperature: 10 sec Time of temperature higher than  $230^{\circ}$ C: 30-60 sec Time to preheat temperature from 180~190°C: 60-120 sec

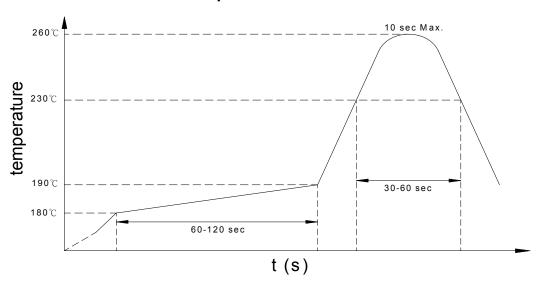
Time(s) of reflow: Two

Flux: Rosin flux containing small amount of chlorine (The

flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

### Recommended Temperature Profile of Infrared Reflow



### (b) Wave soldering:

Temperature: 260°C or below (molten solder temperature)

Time: 10 seconds or less

Preheating conditions: 120°C or below (package surface temperature)

Time(s) of reflow: One

Flux: Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

Fluxes: Avoid removing the residual flux with freon-based and chlorine-based

cleaning solvent.

Avoid shorting between portion of frame and leads.